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SIST EN 61076-3:2002

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EUROPEAN STANDARD  
NORME EUROPÉENNE  
EUROPÄISCHE NORM

**EN 61076-3**

January 2000

ICS 31.220.10

English version

**Connectors for use in d.c., low-frequency analogue  
and digital high-speed data applications  
Part 3: Rectangular connectors with assessed quality  
Sectional specification  
(IEC 61076-3:1999)**

Connecteurs pour applications  
analogiques en courant continu et  
basse fréquence et pour applications  
numériques utilisant des débits élevés  
pour le transfert des données

Partie 3: Connecteurs rectangulaires  
sous assurance de la qualité  
Spécification intermédiaire  
(CEI 61076-3:1999)

Steckverbinder für Gleichspannungs-  
und Niederfrequenzanwendungen  
sowie digitale Anwendungen mit  
hoher Übertragungsrate

Teil 3: Rechteckige Steckverbinder  
mit bewerteter Qualität  
Rahmenspezifikation  
(IEC 61076-3:1999)

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This European Standard was approved by CENELEC on 2000-01-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the Central Secretariat has the same status as the official versions.

CENELEC members are the national electrotechnical committees of Austria, Belgium, Czech Republic, Denmark, Finland, France, Germany, Greece, Iceland, Ireland, Italy, Luxembourg, Netherlands, Norway, Portugal, Spain, Sweden, Switzerland and United Kingdom.

**CENELEC**

European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B - 1050 Brussels

### Foreword

The text of document 48B/790/FDIS, future edition 1 of IEC 61076-3, prepared by SC 48B, Connectors, of IEC TC 48, Electromechanical components and mechanical structures for electronic equipment, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 61076-3 on 2000-01-01.

The following dates were fixed:

- latest date by which the EN has to be implemented  
at national level by publication of an identical  
national standard or by endorsement (dop) 2000-10-01
- latest date by which the national standards conflicting  
with the EN have to be withdrawn (dow) 2003-01-01

Annexes designated "normative" are part of the body of the standard.  
In this standard, annex ZA is normative.  
Annex ZA has been added by CENELEC.

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### **iTeh STANDARD PREVIEW**

#### Endorsement notice

The text of the International Standard IEC 61076-3:1999 was approved by CENELEC as a European Standard without any modification.

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**Annex ZA** (normative)**Normative references to international publications  
with their corresponding European publications**

This European Standard incorporates by dated or undated reference, provisions from other publications. These normative references are cited at the appropriate places in the text and the publications are listed hereafter. For dated references, subsequent amendments to or revisions of any of these publications apply to this European Standard only when incorporated in it by amendment or revision. For undated references the latest edition of the publication referred to applies (including amendments).

NOTE: When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60068-1	1988	Environmental testing Part 1: General and guidance	EN 60068-1 <sup>1)</sup>	1994
IEC 60352-1	1997	Solderless connections Part 1: Wrapped connections - General requirements, test methods and practical guidance	EN 60352-1	1997
IEC 60352-2	1990	Part 2: Solderless crimped connections General requirements, test methods and practical guidance	EN 60352-2	1994
IEC 60352-3	1993	Part 3: Solderless accessible insulation displacement connections - General requirements, test methods and practical guidance	EN 60352-3	1994
IEC 60352-4	1994	Part 4: Solderless non-accessible insulation displacement connections - General requirements, test methods and practical guidance	EN 60352-4	1994
IEC 60352-5	1995	Part 5: Solderless press-in connections General requirements, test methods and practical guidance	EN 60352-5	1995
IEC 60410	1973	Sampling plans and procedures for inspection by attributes	-	-
IEC 60512	series	Electromechanical components for electronic equipment - Basic testing procedures and measuring methods	EN 60512	series

1) EN 60068-1 includes the corrigendum October 1988 and A1:1992 to IEC 60068-1.

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<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 61076-1	1995	Connectors with assessed quality, for use in d.c., low frequency analogue and in digital high-speed data applications Part 1: Generic specification - Capability approval	EN 61076-1	1995

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**CONNECTORS FOR USE IN DC, LOW-FREQUENCY ANALOGUE  
AND DIGITAL HIGH-SPEED DATA APPLICATIONS –****Part 3: Rectangular connectors with assessed quality –  
Sectional specification**

## FOREWORD

- 1) The IEC (International Electrotechnical Commission) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of the IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, the IEC publishes International Standards. Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. The IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
- 2) The formal decisions or agreements of the IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested National Committees.
- 3) The documents produced have the form of recommendations for international use and are published in the form of standards, technical specifications, technical reports or guides and they are accepted by the National Committees in that sense.
- 4) In order to promote international unification, IEC National Committees undertake to apply IEC International Standards transparently to the maximum extent possible in their national and regional standards. Any divergence between the IEC Standard and the corresponding national or regional standard shall be clearly indicated in the latter.
- 5) The IEC provides no marking procedure to indicate its approval and cannot be rendered responsible for any equipment declared to be in conformity with one of its standards.
- 6) Attention is drawn to the possibility that some of the elements of this International Standard may be the subject of patent rights. The IEC shall not be held responsible for identifying any or all such patent rights.

International Standard IEC 61076-3 has been prepared by subcommittee 48B: Connectors, of IEC technical committee 48: Electromechanical components and mechanical structures for electronic equipment.

The text of this standard is based on the following documents:

FDIS	Report on voting
48B/790/FDIS	48B/819/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 3.

This part 3 constitutes the sectional specification in the IEC quality assessment system for electronic components (IECQ) for rectangular connectors.

The other parts form the generic specification and the sectional specifications, some being under consideration or in preparation. For these publications, the QC 480XXX has been reserved.

IEC 61076 was reserved for these series of documents as well as QC 480000; the documents available or under preparation are:

IEC 61076-1: Generic specification

IEC 61076-2: Sectional specification – Circular connectors

IEC 61076-3: Sectional specification – Rectangular connectors

IEC 61076-4: Sectional specification – Printed board connectors

IEC 61076-5: Sectional specification – In-line socket devices

IEC 61076-6: Sectional specification – Loose part contacts

The QC number that appears on the cover of this publication is the specification number of the IEC Quality Assessment System for Electronic Components (IECQ).

The committee has decided that this publication remains valid until 2004. At this date, in accordance with the committee's decision, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

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A bilingual version of this standard may be issued at a later date.

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## CONNECTORS FOR USE IN DC, LOW-FREQUENCY ANALOGUE AND DIGITAL HIGH-SPEED DATA APPLICATIONS –

### Part 3: Rectangular connectors with assessed quality – Sectional specification

## 1 General

### 1.1 Scope

This part of IEC 61076 establishes uniform specifications, type testing requirements and quality assessment procedures for a subfamily of rectangular connectors. It should be used in conjunction with the generic specification IEC 61076-1 and with relevant detail specifications.

### 1.2 Normative references

The following normative documents contain provisions which, through reference in this text, constitute provisions of this part of IEC 61076. For dated references, subsequent amendments to or revisions of, any of these publications do not apply. However, parties to agreements based on this part of IEC 61076 are encouraged to investigate the possibility of applying the most recent editions of the normative documents indicated below. For undated references, the latest edition of the normative document referred to applies. Members of IEC and ISO maintain registers of currently valid International Standards.

IEC 60068-1:1988, *Environmental testing – Part 1: General and guidance*  
SIST EN 61076-3:2002

IEC 60352-1:1997, *Solderless connectors – Part 1: Wrapped connections – General requirements, test methods and practical guidance*  
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IEC 60352-2:1990, *Solderless connections – Part 2: Solderless crimped connections – General requirements, test methods and practical guidance*

IEC 60352-3:1993, *Solderless connections – Part 3: Solderless accessible insulation displacement connections – General requirements, test methods and practical guidance*

IEC 60352-4:1994, *Solderless connections – Part 4: Solderless non-accessible insulation displacement connections – General requirements, test methods and practical guidance*

IEC 60352-5:1995, *Solderless connections – Part 5: Solderless press-in connections – General requirements, test methods and practical guidance*

IEC 60410:1973, *Sampling plans and procedures for inspection by attributes*

IEC 60512 (all parts), *Electromechanical components for electronic equipment – Basic testing procedures and measuring methods*

IEC 61076-1:1995, *Connectors with assessed quality, for use in d.c. low-frequency analogue and digital high-speed data applications – Part 1: Generic specification*